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IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :
TOSHIO SHIOBARA, ET AL. : EXAMINER: FEELY, M.
SERIAL NO: 10/713,163 :
FILED: NOVEMBER 17, 2003 : GROUP ART UNIT: 1712
FOR: WAFER DICING/DIE BONDING :
SHEET

AMENDMENT

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

In response to the Office Action dated February 27, 2006, please amend the application identified above as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 8 of this paper.